30th International Cryogenic Engineering Conference/ International Cryogenic Materials Conference 2026

June 22-26, 2026

Deajeon Convention Center (DCC), Daejeon, Korea

Exhibition & Sponsorship Prospectus



June 22-26, 2026

Deajeon Convention Center (DCC), Daejeon, Korea

Welcome to ICEC30/ICMC2026!

On behalf of the Organizing Committee, it is our great pleasure to welcome you to the 30th International Cryogenic Engineering Conference and International Cryogenic Materials Conference (ICEC30/ICMC2026), to be held in Daejeon, Korea, from June 22 to 26, 2026.

The conference brings together researchers and professionals from academia, industry, and research institutes to share the latest developments and foster collaboration in cryogenic engineering and materials. ICEC30/ICMC2026 will provide a valuable platform to engage with cutting-edge advancements and connect with leading experts in the field.

This year's conference holds special significance as it takes place in Daejeon, the heart of South Korea's science and technology innovation. Known as the "Silicon Valley of Korea," Daejeon offers a dynamic blend of high-tech research and cultural richness. The conference will be held at the Daejeon Convention Center (DCC), a state-of-the-art venue conveniently located near the EXPO Science Park.

We are pleased to offer you an excellent opportunity to showcase your professional services and innovative materials and equipment through sponsorship and exhibition. We encourage you to actively capitalize on this conference to introduce and promote your products and services to a global audience.

Additionally, this event provides a chance for international networking, allowing you to engage with participants from all around the world. We expect this opportunity will serve as a platform for enhancing the visibility and growth of your business.

We eagerly look forward to welcoming you in Daejeon, Korea.

Sincerely Yours,

Sangkwon Jeong
General Chair of the ICEC30/ICMC2026
Professor of KAIST

June 22-26, 2026

Deajeon Convention Center (DCC), Daejeon, Korea

Conference Overview

Date June 22 (Mon.) – 26 (Fri.), 2026

Venue Daejeon Convention Center (DCC), Deajeon, Korea

Organized by The Korean Society of Superconductivity and Cryogenics (KSSC)

Supported by Daejeon Tourism Organization

Attendees & 25 Exhibits (Expected) & Exhibits

Abstract Submission Deadline: January 26 (Mon.), 2026
Important
Acceptance Notification: April 1 (Wed.), 2026

Acceptance Notification: April 1 (Wed.), 2026
Early Registration: February 23 (Mon.) – May 22 (Fri.), 2026

• Paper Submission Deadline: June 29 (Mon.), 2026

Tentative Program

Dates

	June 22 (Mon.)	June 23 (Tue.)		June 24 (Wed.)		June 25 (Thu.)		June 26 (Fri.)
Morning	Registration	Opening Ceremony & Plenary Session	Regis	Plenary Session		Oral Sessions	Regis	Technical Visit
		Coffee Break		Coffee Break		Coffee Break		
		Oral Sessions		Oral Sessions	Regis	Oral Sessions		
Lunch		Lunch	Registration	Lunch	Registration	Lunch	Registration	
Afternoon	Monday Course	Poster Sessions & Coffee Break	า & Exhibition	Poster Sessions & Coffee Break	Դ & Exhibition	Poster Sessions & Coffee Break	ղ & Exhibition	
		Oral Sessions		Oral Sessions		Plenary Session		
Evening	Welcome Reception	Exhibitor Reception				Conference Dinner		

June 22-26, 2026
Deajeon Convention Center (DCC), Daejeon, Korea

Exhibition & Sponsorship

ICEC30/ICMC2026 offers an exceptional opportunity to showcase your latest technologies, materials, and services to a global audience of experts in cryogenic engineering and materials science, while enhancing your visibility and building meaningful partnerships through diverse exhibition and sponsorship opportunities. Join us in Daejeon to network, promote, and grow your global presence!

Exhibition & Sponsorship Fees

Category		Spons	orship	Exhibition		
		Gold	Silver	Double	Single	
		KRW	KRW	KRW	KRW	
		5,000,000	2,000,000	10,000,000	6,000,000	
Exhibition Booth(s)		_	_	6 x 3 m	3 x 3 m	
Advertisement on the Program Book		1 Full Page	Half Page	1 Full Page	Half Page	
Video Advertisement during the Break		0	-	-	-	
Logo Printing	Program Book	0	0	0	0	
	Banner at the Venue	0	0	0	0	
	Screen at Session Room	0	0	0	0	
Web Banner	Official Website	0	0	0	0	
(Logo + Link)	E-Newsletter	0	0	0	0	
Complimentary Badges		1	_	2	1	

Exhibition Booth Information

	Double	Single
Booths	6 x 3 m Booths	3 x 3 m Booths
Includes	2 information desks4 chairs1kW of Power (220 V, 60 Hz)	1 information desk2 chairs1kW of Power (220 V, 60 Hz)

Application Procedure

- Please fill out the application form and e-mail it to the ICEC 30/ ICMC2026 secretariat (secretariat@icec30-icmc2026.org) with a copy of business registration certificate by April 3 (Fri.), 2026
- The exhibition booths are on first-come, first-served basis.

Cancellation Policy

- Written cancellations received on or before April 3 (Fri.), 2026 will be refunded 80% of the total payment. No refunds will be issued for cancellations received after April 3 (Fri.), 2026.
- All cancellations of exhibition and sponsorship must be submitted in writing to the Secretariat via email.

June 22-26, 2026

Deajeon Convention Center (DCC), Daejeon, Korea

Application Form

Please fill out the below application form, and send it back to the secretariat.

ICEC 30/ ICMC2026 Secretariat

E-mail: <u>secretariat@icec30-icmc2026.org</u> / Tel: +82-42-472-7460

Company Information

Company Name		
Address		
Website		
President		
Contact Person Name	Job Title / Department	
Telephone	Mobile	
E-mail		

Exhibition & Sponsorship

Category		KRW	Apply (Check "O")		
Sponsorship	Gold	KRW 5,000,000			
	Silver	KRW 2,000,000			
Exhibition	Double	KRW 10,000,000			
	Single	KRW 6,000,000			

Payment Method (Wire Transfer Only)

 Account Holder: The Korean Society of Superco 	nductivity and Cryogenics
Account Number: 1005-204-709592	
■ Bank Name: WOORIBANK	
■ SWIFT Code: HVBKKRSEXXX	
■ Bank Address: 17 WORLDCUP BUK RO,MAPO	GU,SEOUL SOUTH KOREA 03921
※ Application Deadline: April 3 (Fri.), 2026	
Name of Applicant:	Date:

Signature: .